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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









2.5x0.7mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APFA2507QBDSEEZGKC

Blue Hyper Red Green

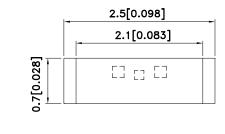
Features

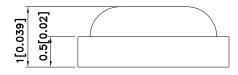
- 2.5x1.0x0.7mm right angle SMD LED, 0.7mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 3000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

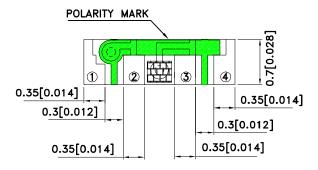
Descriptions

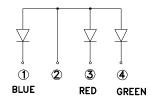
- The Blue source color devices are made with InGaN on Sapphire Light Emitting Diode.
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- Electrostatic discharge and power surge could damage
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

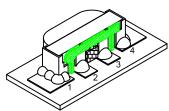
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APFA2507QBDSEEZGKC	Blue (InGaN)	Water Clear	40	65	140°
	Hyper Red (AlGaInP)		80	110	110°
	Green (InGaN)		200	400	130°

Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Hyper Red Green	460 630 515		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue Hyper Red Green	465 621 525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue Hyper Red Green	25 20 35		nm	IF=20mA
С	Capacitance	Blue Hyper Red Green	100 25 45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue Hyper Red Green	3.3 2 3.3	4 2.5 4.1	V	IF=20mA
lr	Reverse Current	Blue Hyper Red Green		50 10 50	uA	VR=5V

Notes:

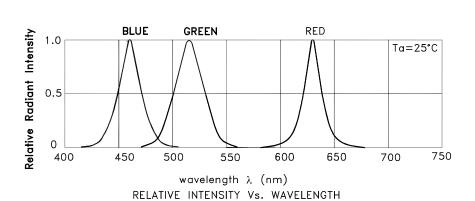
- 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

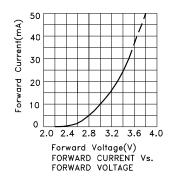
Parameter	Blue	Hyper Red	Green	Units		
Power dissipation	120	75	102.5	mW		
DC Forward Current	30	30	25	mA		
Peak Forward Current [1]	150	195	150	mA		
Electrostatic Discharge Threshold (HBM)	250	-	450	V		
Reverse Voltage	5			V		
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

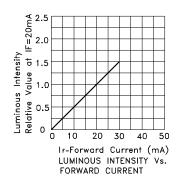
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

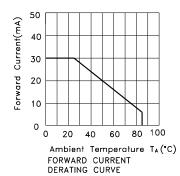
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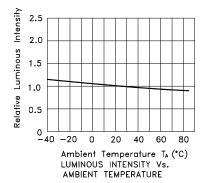


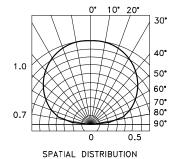
APFA2507QBDSEEZGKC Blue







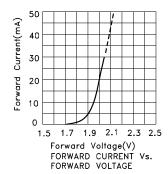


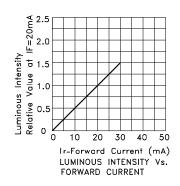


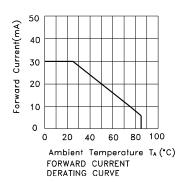
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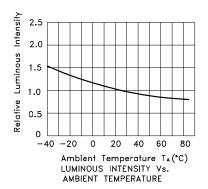
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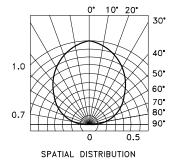
Hyper Red





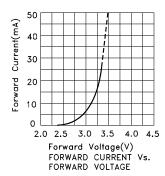


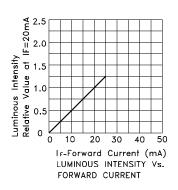


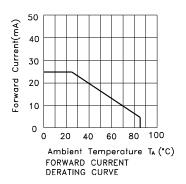


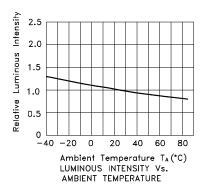
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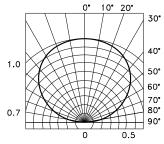
Green











SPATIAL DISTRIBUTION

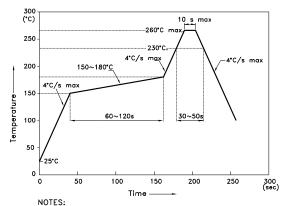
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

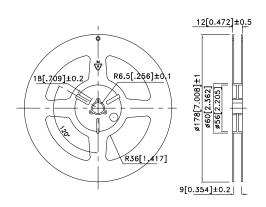
 3.Number of reflow process shall be 2 times or less.

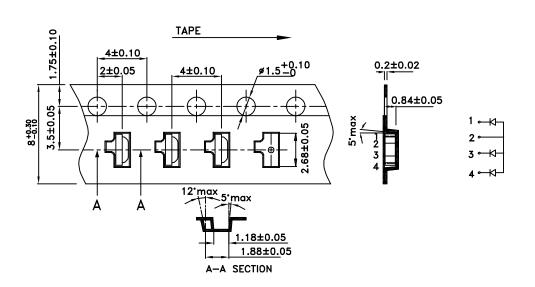
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

1.8

Tape Dimensions (Units: mm)

Reel Dimension



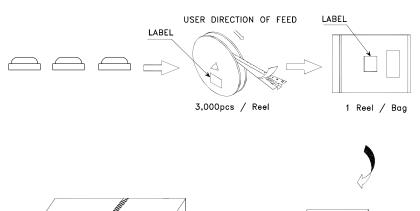


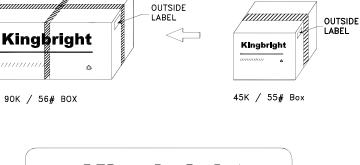
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PACKING & LABEL SPECIFICATIONS

APFA2507QBDSEEZGKC







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